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Product data sheet

1. General description

The 74LV08 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC08 and 74HCT08.

The 74LV08 provides a quad 2-input AND function.

2. Features and benefits

- Wide operating voltage: 1.0 V to 5.5 V
- Optimized for low voltage applications: 1.0 V to 3.6 V
- Accepts TTL input levels between $V_{CC} = 2.7$ V and $V_{CC} = 3.6$ V
- Typical output ground bounce < 0.8 V at V_{CC} = 3.3 V and T_{amb} = 25 °C
- Typical HIGH-level output voltage (V_{OH}) undershoot: > 2 V at V_{CC} = 3.3 V and T_{amb} = 25 °C
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

3. Ordering information

Ordering information

Table 1.

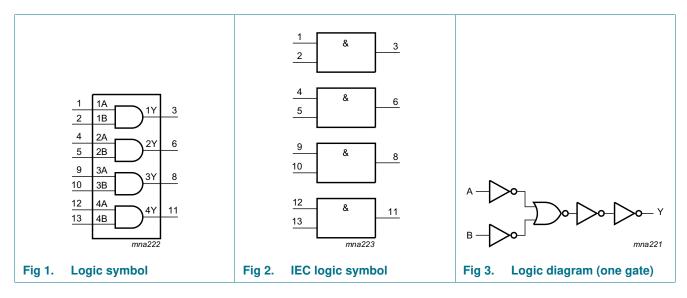
Type number	Package						
	Temperature range	Name	Description	Version			
74LV08D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width 3.9 mm	SOT108-1			
74LV08DB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body width 5.3 mm	SOT337-1			
74LV08PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads; body width 4.4 mm	SOT402-1			



Quad 2-input AND gate

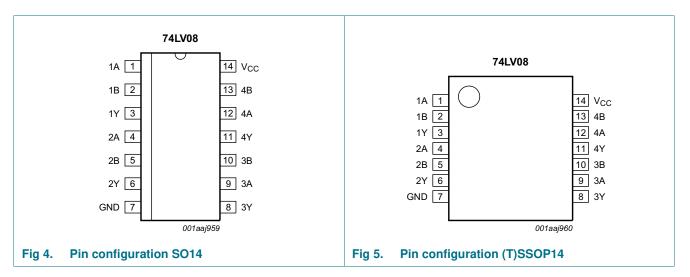
74LV08

4. Functional diagram



5. Pinning information

5.1 Pinning



5.2 Pin description

Table 2. Pin description		
Symbol	Pin	Description
1A, 2A, 3A, 4A	1, 4, 9, 12	data input
1B, 2B, 3B, 4B	2, 5, 10, 13	data input
1Y, 2Y, 3Y, 4Y	3, 6, 8, 11	data output
GND	7	ground (0 V)
V _{CC}	14	supply voltage

6. Functional description

Table 3. Function selection^[1]

Input		Output
nA	nB	nY
L	X	L
Х	L	L
Н	Н	Н

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{CC} + 0.5$ V	<u>[1]</u>	-	±20	mA
I _{OK}	output clamping current	$V_O < -0.5$ V or $V_O > V_{CC}$ + 0.5 V	<u>[1]</u>	-	±50	mA
lo	output current	$V_{O} = -0.5$ V to (V _{CC} + 0.5 V)		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \text{ °C to } +125 \text{ °C}$	[2]			
		SO14, SSOP14, TSSOP14		-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage ^[1]		1.0	3.3	5.5	V
VI	input voltage		0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 1.0 \text{ V} \text{ to } 2.0 \text{ V}$	-	-	500	ns/V
		$V_{CC} = 2.0 \text{ V} \text{ to } 2.7 \text{ V}$	-	-	200	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	100	ns/V
		$V_{CC} = 3.6 \text{ V} \text{ to } 5.5 \text{ V}$	-	-	50	ns/V

[1] The static characteristics are guaranteed from $V_{CC} = 1.2$ V to $V_{CC} = 5.5$ V, but LV devices are guaranteed to function down to $V_{CC} = 1.0$ V (with input levels GND or V_{CC}).

9. Static characteristics

Table 6. Static characteristics

Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	–40 °C to +85 °C			–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
V _{IH}	HIGH-level input	V _{CC} = 1.2 V	0.9	-	-	0.9	-	V	
	voltage	V _{CC} = 2.0 V	1.4	-	-	1.4	-	V	
		V _{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V	
		V _{CC} = 4.5 V to 5.5 V	$0.7V_{CC}$	-	-	$0.7V_{CC}$	-	V	
V _{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.3	-	0.3	V	
	voltage	V _{CC} = 2.0 V	-	-	0.6	-	0.6	V	
		V _{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V	
		V _{CC} = 4.5 V to 5.5 V	-	-	0.3V _{CC}	-	$0.3V_{CC}$	V	
V _{ОН}	HIGH-level output voltage	$V_{I} = V_{IH} \text{ or } V_{IL}$							
		$I_{O} = -100 \ \mu A; \ V_{CC} = 1.2 \ V$	-	1.2	-	-	-	V	
		$I_{O} = -100 \ \mu A; \ V_{CC} = 2.0 \ V$	1.8	2.0	-	1.8	-	V	
		$I_{O} = -100 \ \mu A; \ V_{CC} = 2.7 \ V$	2.5	2.7	-	2.5	-	V	
		$I_{O} = -100 \ \mu A; \ V_{CC} = 3.0 \ V$	2.8	3.0	-	2.8	-	V	
		$I_{O} = -100 \ \mu A; V_{CC} = 4.5 \ V$	4.3	4.5	-	4.3	-	V	
		$I_{O} = -6 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	2.82	-	2.2	-	V	
		$I_{O} = -12 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.6	4.2	-	3.5	-	V	

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Quad 2-input AND gate

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Symbol	Parameter	arameter Conditions		–40 °C to +85 °C			–40 °C to +125 °C	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
V _{OL}	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	voltage	$I_{O} = 100 \ \mu A; V_{CC} = 1.2 \ V$	-	0	-	-	-	V
		$I_{O} = 100 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.2	-	0.2	V
		$I_{O} = 100 \ \mu A; V_{CC} = 2.7 \ V$	-	0	0.2	-	0.2	V
		$I_{O} = 100 \ \mu A; V_{CC} = 3.0 \ V$	-	0	0.2	-	0.2	V
		$I_{O} = 100 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.2	-	0.2	V
		I _O = 6 mA; V _{CC} = 3.0 V	-	0.25	0.40	-	0.50	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.35	0.55	-	0.65	V
l _l	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	1.0	-	1.0	μA
I _{CC}	supply current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{CC} \text{ or } \text{GND}; \ I_{O} = 0 \ \text{A}; \\ V_{CC} = 5.5 \ \text{V} \end{array}$	-	-	20.0	-	40	μA
Δl _{CC}	additional supply current	per input; V _I = V _{CC} – 0.6 V; V _{CC} = 2.7 V to 3.6 V	-	-	500	-	850	μA
Cı	input capacitance		-	3.5	-	-	-	pF

 Table 6.
 Static characteristics ... continued

 Voltages are referenced to GND (ground = 0 V).

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

10. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; For test circuit see Figure 7.

Symbol	Parameter	Conditions		–40 °C to +85 °C			–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	nA, nB to nY; see <u>Figure 6</u>	[2]						
		V _{CC} = 1.2 V		-	45	-	-	-	ns
		V _{CC} = 2.0 V		-	15	26	-	33	ns
		V _{CC} = 2.7 V		-	11	17	-	21	ns
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V; $C_L = 15 \text{ pF}$	[3]	-	7	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V	[3]	-	9.0	15	-	19	ns
		V _{CC} = 4.5 V to 5.5 V		-	-	11	-	14	ns
C _{PD}	power dissipation capacitance	$\begin{array}{l} C_L = 50 \text{ pF; } f_i = 1 \text{ MHz;} \\ V_I = \text{GND to } V_{CC} \end{array}$	[4]	-	10	-	-	-	pF

[1] All typical values are measured at $T_{amb} = 25 \text{ °C}$.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V).

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \Sigma(C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 $f_i = \text{input}$ frequency in MHz, $f_o = \text{output}$ frequency in MHz

 C_L = output load capacitance in pF

 V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}{}^2 \times f_o)$ = sum of the outputs.

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11. Waveforms

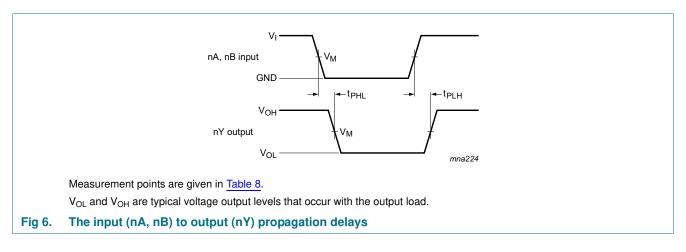


Table 8.Measurement points

Supply voltage	Input	Output
V _{cc}	V _M	V _M
< 2.7 V	0.5V _{CC}	0.5V _{CC}
2.7 V to 3.6 V	1.5 V	1.5 V
≥ 4.5 V	0.5V _{CC}	0.5V _{CC}

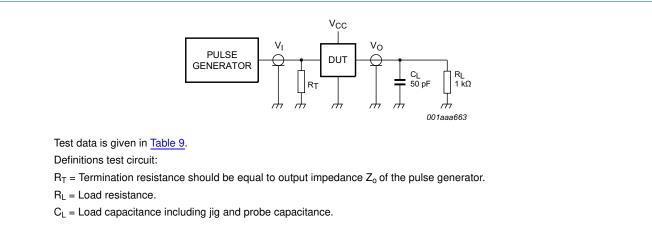


Fig 7. Test circuit for measuring switching times

Tab	le 9.	Test data

Supply voltage	Input		
V _{cc}	VI	t _r , t _f	
< 2.7 V	V _{CC}	≤ 2.5 ns	
2.7 V to 3.6 V	2.7 V	≤ 2.5 ns	
≥ 4.5 V	V _{CC}	≤ 2.5 ns	

74LV08 Quad 2-input AND gate

12. Package outline

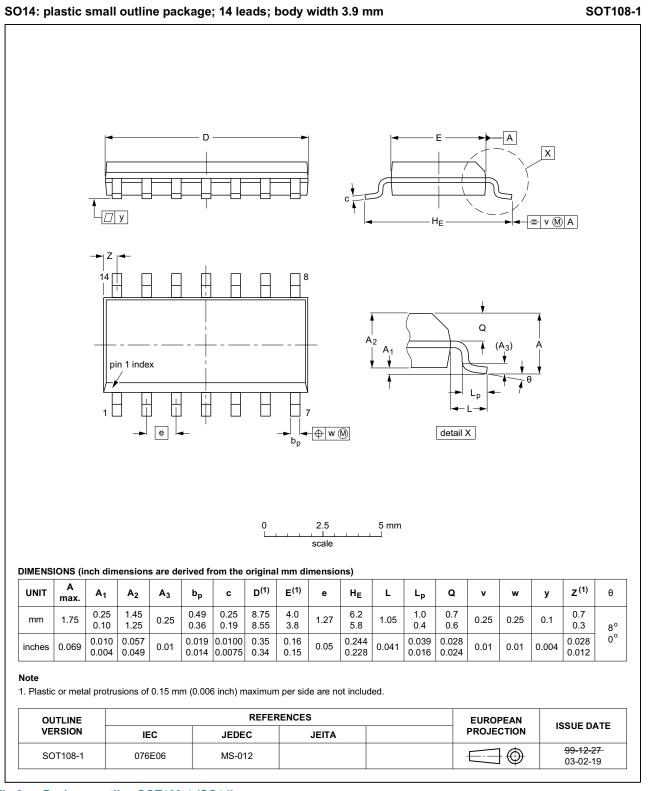
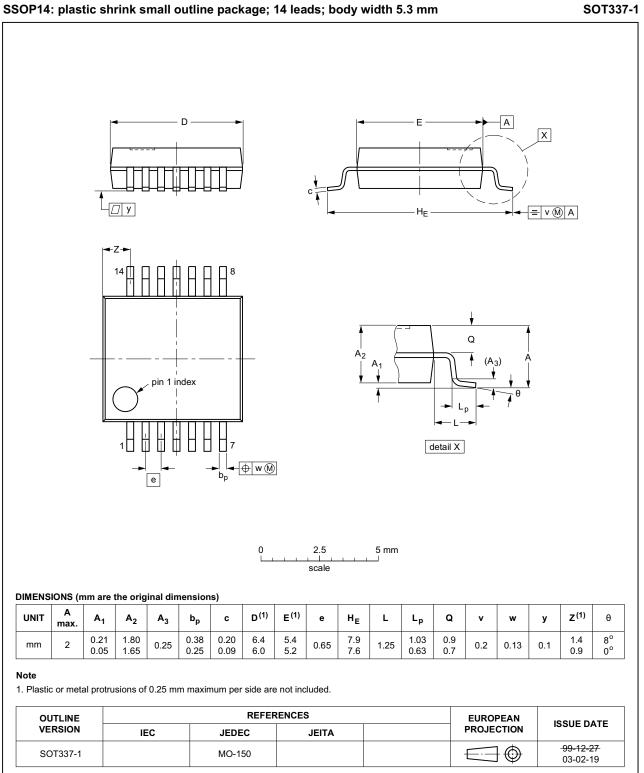


Fig 8. Package outline SOT108-1 (SO14)

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SSOP14: plastic shrink small outline package; 14 leads; body width 5.3 mm

Package outline SOT337-1 (SSOP14) Fig 9.

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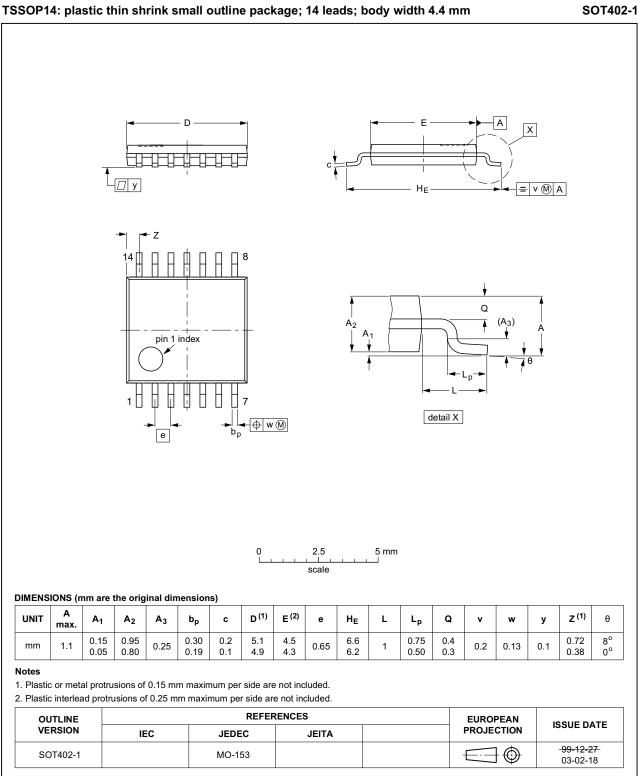


Fig 10. Package outline SOT402-1 (TSSOP14)

13. Abbreviations

Table 10. Abbreviations		
Acronym	Description	
CMOS	Complementary Metal Oxide Semiconductor	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	

14. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LV08 v.4	20151208	Product data sheet	-	74LV08 v.3	
Modifications:	Type number 74LV08N (SOT27-1) removed.				
74LV08 v.3	20090406	Product data sheet	-	74LV08 v.2	
Modifications:	• The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors.				
	 Legal texts have been adapted to the new company name when appropriate. 				
74LV08 v.2	19980420	Product specification	-	74LV08 v.1	
74LV08 v.1	19970203	Product specification	-	-	

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Document status[1][2]	Product status ^[3]	Definition
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Quad 2-input AND gate

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